

CMOS Digital Integrated Circuits Silicon Monolithic

TC74ACT32P

1. Functional Description

• Quad 2-Input OR Gate

2. General

The TC74ACT32P is an advanced high speed CMOS 2-INPUT OR GATE fabricated with silicon gate and double layer metal wiring C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

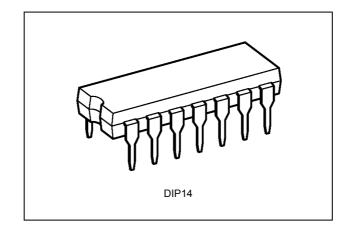
This device may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

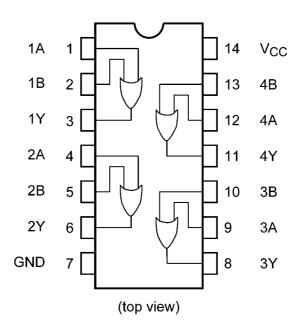
3. Features

- (1) High speed: t_{pd} = 4.5 ns (typ.) at V_{CC} = 5 V
- (2) Low power dissipation: $I_{CC} = 4 \ \mu A \ (max)$ at $T_a = 25 \ ^{\circ}C$
- (3) Compatible with TTL outputs: V_{IL} = 0.8 V (max), V_{IH} = 2.0 V (min)
- (4) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA} (\text{min}) (V_{CC} = 4.5 \text{ V})$
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Pin and function compatible with 74F32.

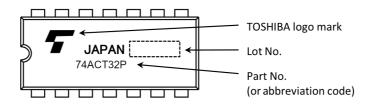
4. Packaging



5. Pin Assignment



6. Marking



7. IEC Logic Symbol

≥ 1	(3) 1V
	(<u>3)</u> 1Y
	(6) 24
	(<u>6)</u> 2Y
	<u>(8)</u> 3Y
	3Y
	(<u>11)</u> 4Y
	4 Y
	≥ 1

8. Truth Table

А	В	Y
Н	Н	Н
L	Н	Н
Н	L	Н
L	L	L

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{ОК}		±50	mA
Output current	I _{OUT}		±50	mA
V _{CC} /ground current	I _{CC}		±100	mA
Power dissipation	PD	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of $T_a = -40$ to 65 °C. From $T_a = 65$ to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	VIH	—		4.5 to 5.5	2.0	—	_	V
Low-level input voltage	VIL	—		4.5 to 5.5	_	_	0.8	V
High-level output voltage	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -50 μA	4.5	4.4	4.5	_	V
			I _{OH} = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IL}	I _{OL} = 50 μA	4.5	_	0.0	0.1	V
			I _{OL} = 24 mA	4.5	_	_	0.36	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND	V _{IN} = V _{CC} or GND		_	_	±0.1	μA
Quiescent supply	I _{CC}	V _{IN} = V _{CC} or GND		5.5	—	—	4.0	μA
current	I _{CCT}	Per input: V_{CC} = 3.4 V Other input: V_{CC} or GNI	D	5.5	—	—	1.35	mA

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	VIH	—			4.5 to 5.5	2.0	_	V
Low-level input voltage	VIL	—			4.5 to 5.5	_	0.8	V
High-level output voltage	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -50 μA		4.5	4.4		V
			I _{OH} = -24 mA		4.5	3.80	_	
			I _{OH} = -75 mA	(Note 1)	5.5	3.85		
Low-level output voltage	V _{OL}	$V_{IN} = V_{IL}$	I _{OL} = 50 μA		4.5	_	0.1	V
			I _{OL} = 24 mA		4.5		0.44	
			I _{OL} = 75 mA	(Note 1)	5.5		1.65	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5	_	±1.0	μA
Quiescent supply	I _{CC}	V _{IN} = V _{CC} or GND			5.5		40.0	μA
current	I _{CCT}	Per input: V_{CC} = 3.4 V Other input: V_{CC} or GNE)		5.5	_	1.5	mA

Note 1: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested within a 10 ms maximum duration.

11.3. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		C _L = 50 pF, RL = 500 Ω	5.0 ± 0.5	_	5.2	7.9	ns
Input capacitance	C _{IN}		_		_	5	10	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_		_	22		pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

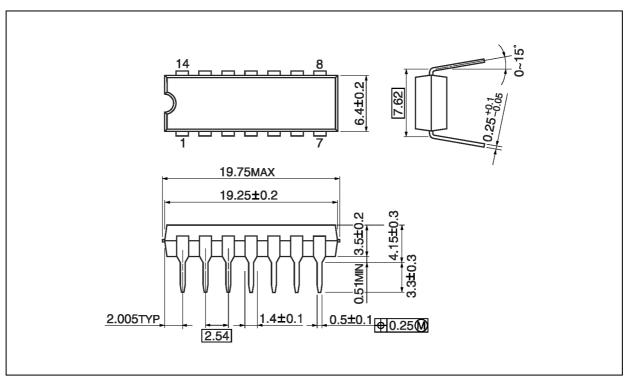
 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4$ (per gate)

11.4. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	C_L = 50 pF, RL = 500 Ω	5.0 ± 0.5	1.0	9.0	ns
Input capacitance	C _{IN}	_		_	10	pF

Package Dimensions

Unit: mm



Weight: 0.96 g (typ.)

	Package Name(s)
Nickname: DIP14	

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